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JC525 U.S. PTO

PATENT APPLICATION
Attorney's Do. No. 9903-40

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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ADRIENNE CHOCHOLAK
(SENDER'S PRINTED NAME)

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(SIGNATURE)

1002 U.S. PTO
10/053278

01/16/02

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

Enclosed for filing is a patent application under 37 CFR 1.53(b) of:

Inventor Hyung-Jik BYUN and Hyu-Jin LEE:
For: SEMICONDUCTOR CHIP PACKAGE COMPRISING ENHANCED
 PADS

Applicant requests FIG. 5 to be published with the application.

Enclosures:

- ☒ Specification (pages 1-7); claims (pages 8-11); abstract (page 12)
☒ SEVEN sheet(s) of FORMAL drawings
☒ Declaration or Combined Declaration and Power of Attorney
☒ Newly executed (original or copy)
☒ Assignment with cover sheet
Assignee Name and Address: Samsung Electronics Co., Ltd.
 Suwon-city, Kyungki-do, Korea
☒ Certified copy of Priority Document No. 2001-5383, filed February 5, 2001
☒ Return Postcard

CLAIMS AS FILED				
For	Number Filed	Number Extra	Rate	Basic Fee \$740
Total Claims	26-20	6	x \$ 18 =	108
Independent Claims	4-3	1	x \$ 84 =	84
TOTAL FILING FEE				\$932



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Respectfully submitted,

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